

Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

eSMP[®] Series

SMP (DO-220AA)

Cathode Anode

FEATURES

- Low profile package
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE
LINKS TO ADDITIONAL RESOURCES


3D Models

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2.0 A
V_{RRM}	200 V
I_{FSM}	50 A
V_F at $I_F = 2.0$ A	0.68 V
T_J max.	175 °C
Package	SMP (DO-220AA)
Circuit configuration	Single

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA
Case: SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)			
PARAMETER	SYMBOL	V2P22L	UNIT
Device marking code		V2D	
Maximum repetitive peak reverse voltage	V_{RRM}	200	V
Maximum DC forward current	$I_{F(AV)}$ ⁽¹⁾	2	A
	$I_{F(AV)}$ ⁽²⁾	1.6	A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	50	A
Operating junction and storage temperature range	T_J ⁽³⁾	-40 to +175	°C
Operating junction and storage temperature range	T_{STG}	-55 to +175	°C

Notes

⁽¹⁾ Mounted on 10 mm x 10 mm PCB pad area

⁽²⁾ Free air, mounted on recommended copper pad area

⁽³⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	$I_F = 1.0\text{ A}$	$T_A = 25\text{ }^\circ\text{C}$	$V_F^{(1)}$	0.76	-	V
	$I_F = 2.0\text{ A}$			0.83	0.91	
	$I_F = 1.0\text{ A}$	$T_A = 125\text{ }^\circ\text{C}$		0.60	-	
	$I_F = 2.0\text{ A}$			0.68	0.76	
Reverse current	$V_R = 160\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$	$I_R^{(2)}$	0.001	-	mA
		$T_A = 125\text{ }^\circ\text{C}$		0.2	-	
	$V_R = 200\text{ V}$	$T_A = 25\text{ }^\circ\text{C}$		-	0.04	mA
		$T_A = 125\text{ }^\circ\text{C}$		0.4	2.0	
Typical junction capacitance	4.0 V, 1 MHz		C_J	90.0	-	pF

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: pulse width $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified)			
PARAMETER	SYMBOL	V2P22L	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	125	$^\circ\text{C/W}$
	$R_{\theta JM}^{(3)}$	15	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction-to-ambient
(3) Mounted on 10 mm x 10 mm aluminum PCB; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V2P22L-M3/H	0.024	H	3000	7" diameter plastic tape and reel
V2P22L-M3/I	0.024	I	10 000	13" diameter plastic tape and reel
V2P22LHM3/H ⁽¹⁾	0.024	H	3000	7" diameter plastic tape and reel
V2P22LHM3/I ⁽¹⁾	0.024	I	10 000	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

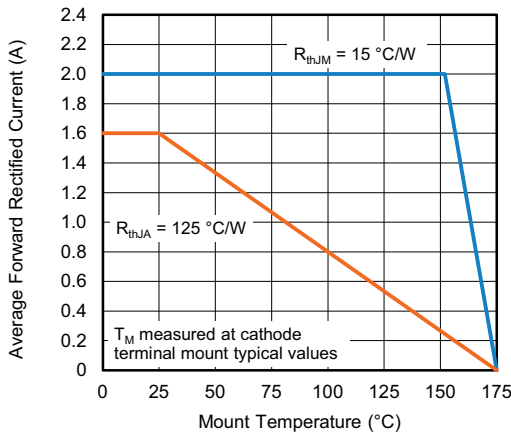


Fig. 1 - Maximum Forward Current Derating Curve

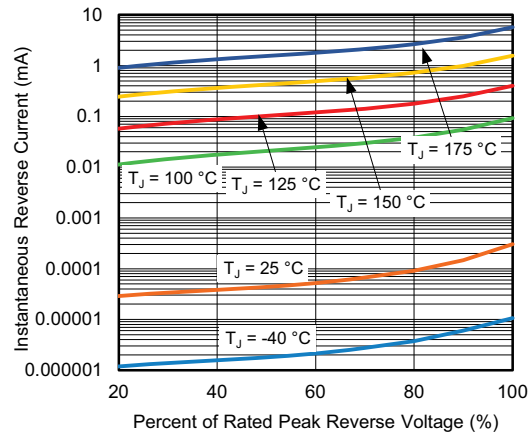


Fig. 4 - Typical Reverse Characteristics

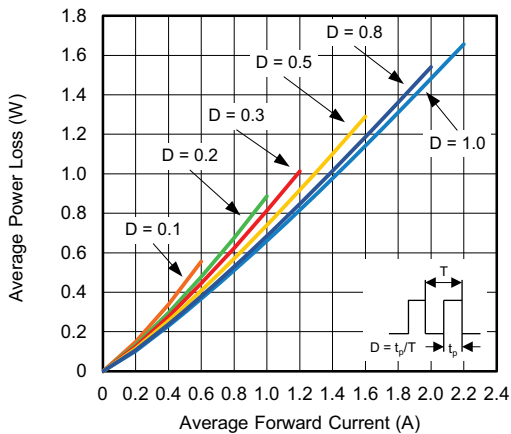


Fig. 2 - Forward Power Loss Characteristics

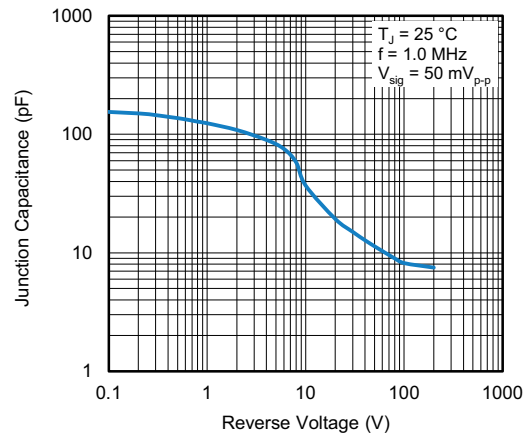


Fig. 5 - Typical Junction Capacitance

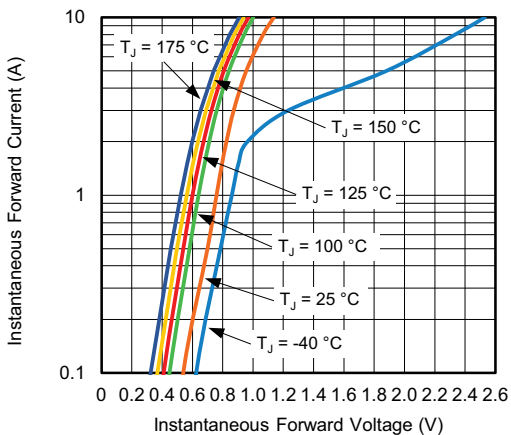


Fig. 3 - Typical Instantaneous Forward Characteristics

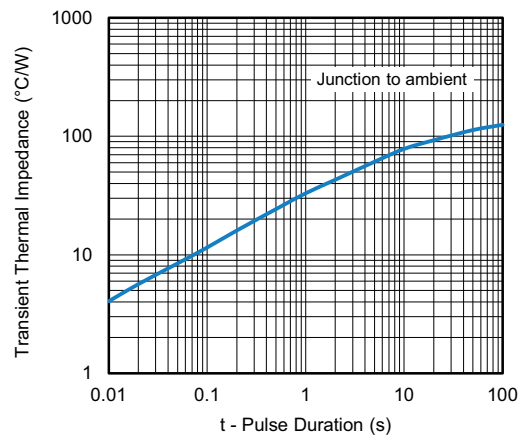
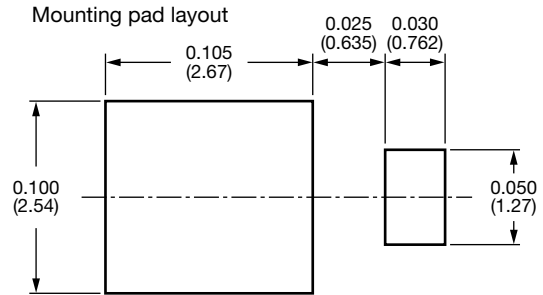
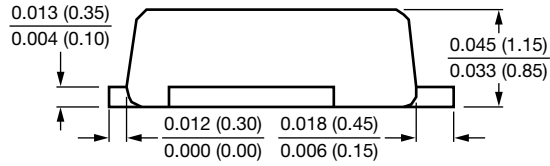
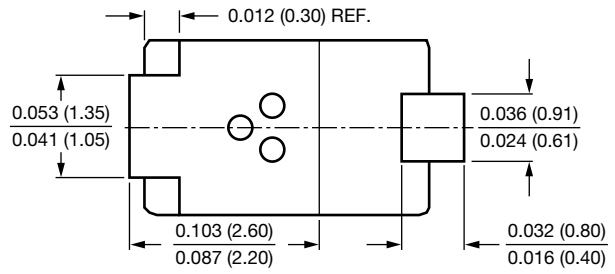
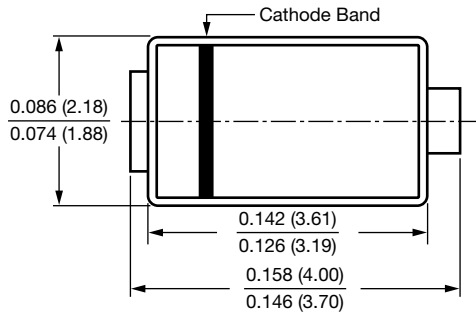


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMP (DO-220AA)





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